

March 2011 UniFET-II[™]

FDP5N60NZ / FDPF5N60NZ N-Channel MOSFET 600V, 4.5A, 2.0 Ω

Features

- $R_{DS(on)} = 1.65\Omega$ (Typ.)@ $V_{GS} = 10V$, $I_D = 2.25A$
- Low Gate Charge (Typ. 10nC)
- Low C_{rss} (Typ. 5pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol			FDP5N60NZ	FDPF5N60NZ	Units	
V _{DSS}	Drain to Source Voltage			600		V
V _{GSS}	Gate to Source Voltage			ŧ	-25	V
I _D	Drain Current	- Continuous ($T_C = 25^{\circ}C$)		4.5	4.5*	^
		- Continuous ($T_c = 100^{\circ}C$)		2.7	2.7*	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	18	18*	Α
E _{AS}	Single Pulsed Avalanche	(Note 2)	175		mJ	
I _{AR}	Avalanche Current			4.5		Α
E _{AR}	Repetitive Avalanche Energy		(Note 1)	10		mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	10		V/ns
P _D	Dewer Dissignation	$(T_{C} = 25^{\circ}C)$		100	33	W
	Power Dissipation	- Derate above 25°C	- Derate above 25°C		0.27	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150		°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C

*Dran current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FDP5N60NZ	FDPF5N60NZ	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.25	3.75	
$R_{\theta CS}$	Thermal Resistance, Case to Sink Typ	0.5	-	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

FDP5N60NZ FDP5N60NZ TO		Package	age Reel Size Ta		Тар	e Width		Quantit	у	
		TO-220)	-		-		50		
		TO-220F	-	-		-		50		
Electrica	I Char	acteristics T _c =	25°C unless o	otherwise	noted					
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Units
Off Charac	teristic	S								
BV _{DSS}	Drain to	Source Breakdown Vo	oltage	I _D = 250	μΑ, V _{GS} = 0V		600	-	-	V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient		ure	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		25°C	-	0.6	-	V/°C
	7			$V_{DS} = 600V, V_{GS} = 0V$			-	-	1	
DSS	Zero Ga	ate Voltage Drain Curre	HIL	-	30V, T _C = 125°C		-	-	10	μA
I _{GSS}	Gate to	Body Leakage Curren	t	$V_{GS} = \pm 2$	25V, V _{DS} = 0V		-	-	±10	μA
On Charac	teristic	s								
V _{GS(th)}	Gate Threshold Voltage			V _{GS} = V	/ _{GS} = V _{DS} , I _D = 250μA			-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance			$V_{GS} = 10V, I_D = 2.25A$			-	1.65	2.0	Ω
9 _{FS}	Forward Transconductance			V _{DS} = 20V, I _D =2.25A -		-	5	-	S	
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance		3	V _{DS} = 25V, V _{GS} = 0V _ f = 1MHz			450 50 5	600 65 7.5	pF pF pF	
Q _g		ate Charge at 10V					-	10	13	nC
Q _{gs}	Gate to Source Gate Charge			$V_{DS} = 480V, I_D = 4.5A$		-	-	2.5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			V _{GS} = 10V		-	-	4	-	nC
Switching	Charac	teristics								
t _{d(on)}	Turn-On Delay Time						-	15	40	ns
t _r	Turn-Or	n Rise Time		$\frac{V_{DD} = 300V, I_D = 4.5A}{R_G = 25\Omega}$			-	20	50	ns
t _{d(off)}	Turn-Of	f Delay Time					-	35	80	ns
t _f	Turn-Of	f Fall Time		1			-	20	50	ns
Drain-Sou	rce Dioo	de Characteristic	s							
I _S	1	m Continuous Drain to	-	Forward	Current		-	-	4.5	Α
I _{SM}	Maximum Pulsed Drain to Source Diode For			rward Current			-	-	18	Α
V _{SD}	Drain to	Drain to Source Diode Forward Voltage			V _{GS} = 0V, I _{SD} = 4.5A		-	-	1.4	V
t _{rr}	Reverse	e Recovery Time		$V_{GS} = 0^{1}$	√, I _{SD} = 4.5A		-	230	-	ns
Q _{rr}	Reverse	Recovery Charge		$dI_F/dt = 100A/\mu s$			_	0.9	-	μC

2. L = 17.3mH, I_{AS} = 4.5A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. $I_{SD} \leq 4.5 \text{A}, \ di/dt \leq 200 \text{A}/\mu \text{s}, \ V_{DD} \leq \text{BV}_{DSS}, \ \text{Starting} \ T_J = 25^\circ \text{C}$ 4. Pulse test: Pulse width $\leq 300 \mu \text{s}, \text{Duty Cycle} \leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics

1. V_{DS} = 20V

*Notes:

1.0

1. V_{GS} = 0V

2. 250µs Pulse Test

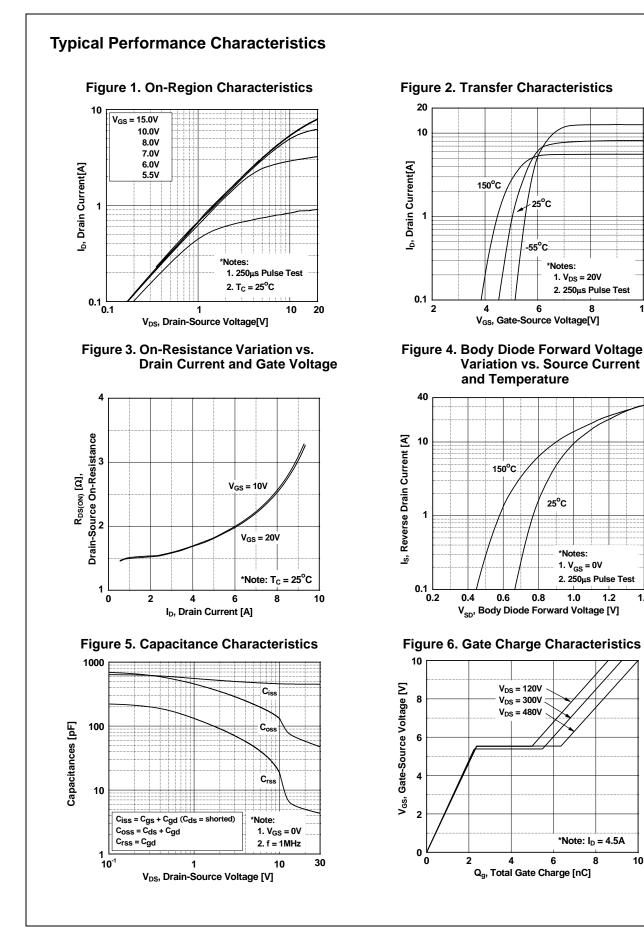
1.2

1.4

2. 250µs Pulse Test

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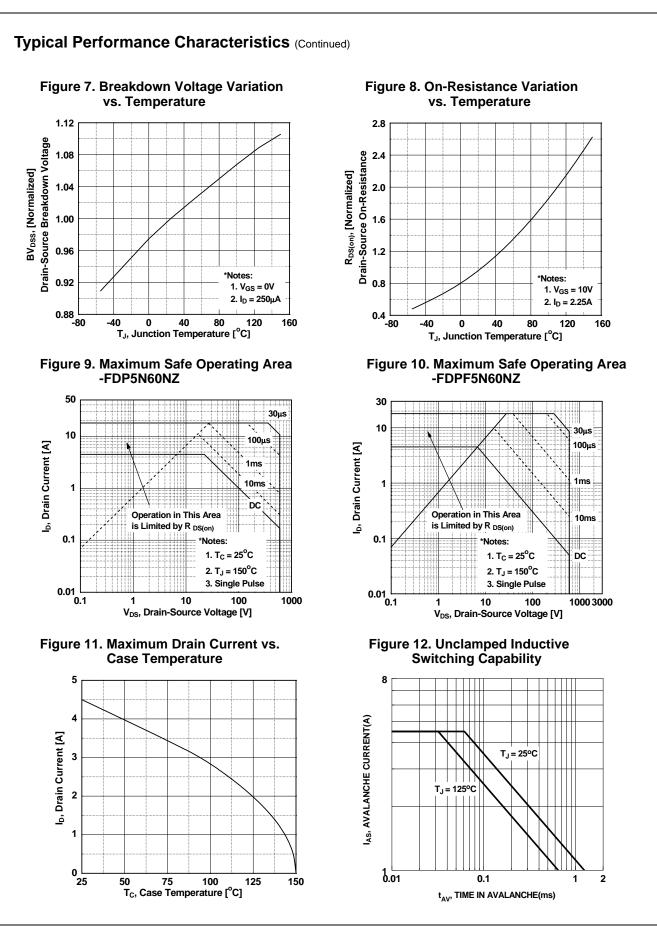
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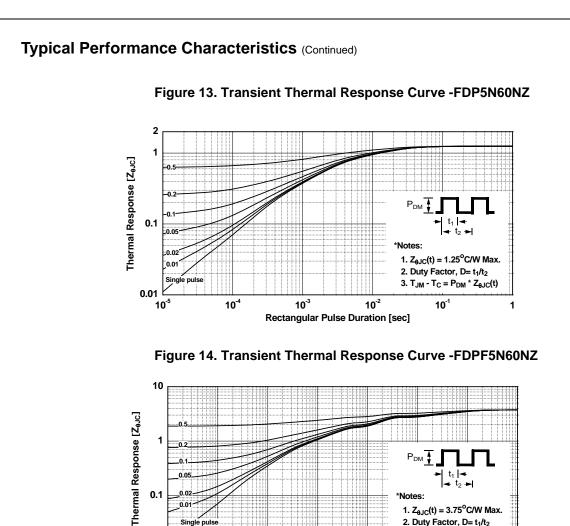


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*Note: I_D = 4.5A

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10⁻²

10⁻¹

Rectangular Pulse Duration [sec]

FDP5N60NZ / FDPF5N60NZ N-Channel MOSFET

0.1

0.01

10⁻⁵

0 01

10⁻⁴

10⁻³

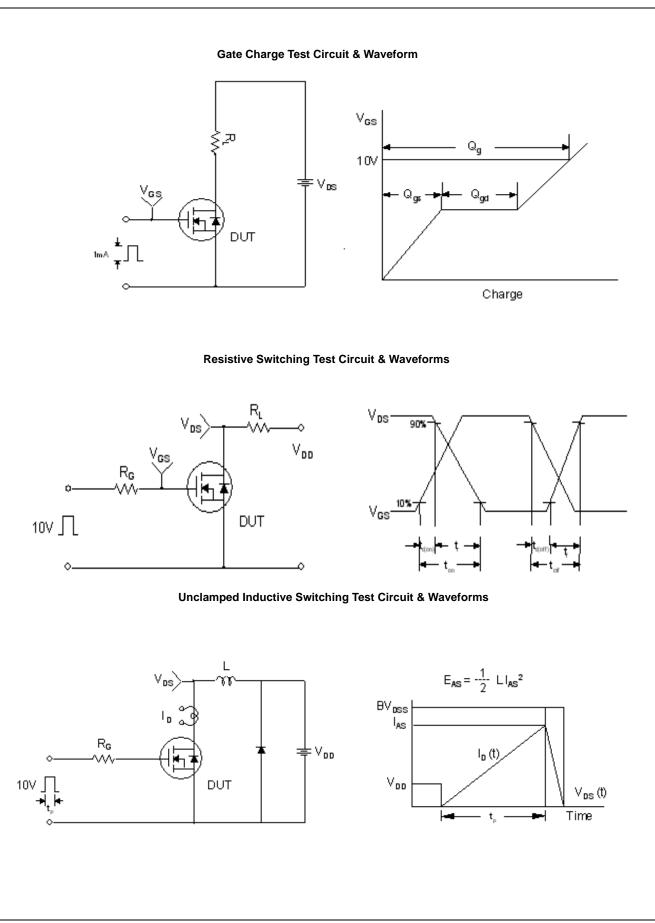
Notes

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1. $Z_{\theta JC}(t) = 3.75^{\circ}C/W$ Max. 2. Duty Factor, $D = t_1/t_2$ 3. T_{JM} - $T_C = P_{DM} * Z_{\theta JC}(t)$

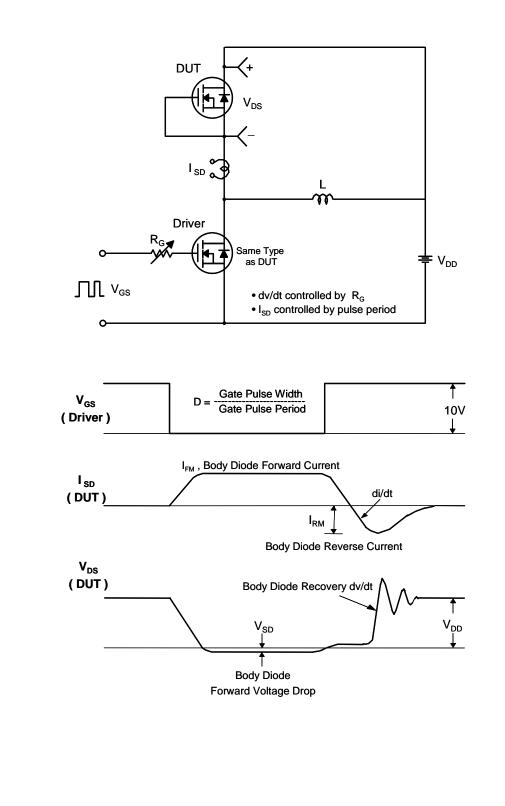
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10²



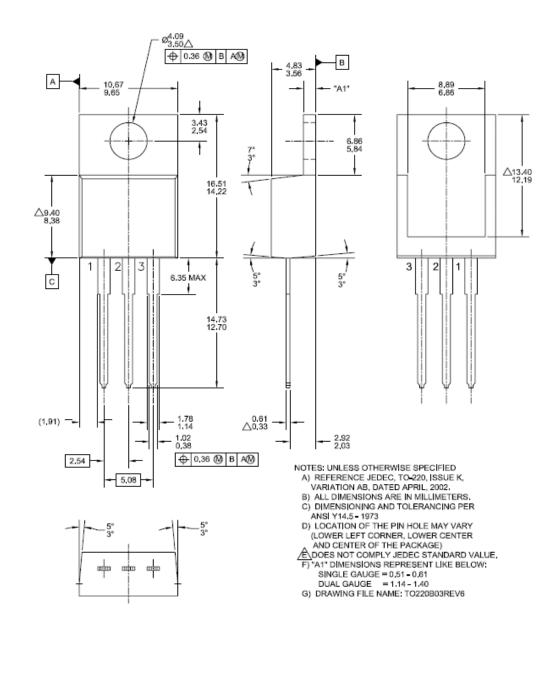
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Peak Diode Recovery dv/dt Test Circuit & Waveforms

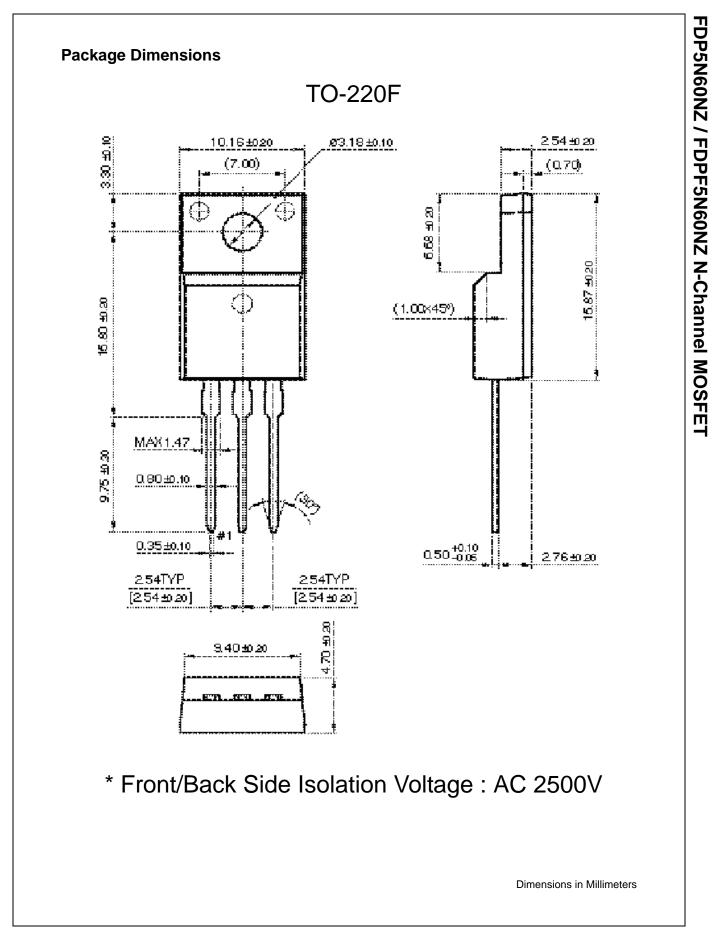


Mechanical Dimensions

TO-220



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